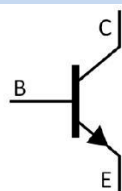


/ Descriptions

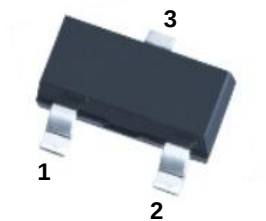
/ Features

/ Applications

/ Equivalent Circuit



/ Pinning



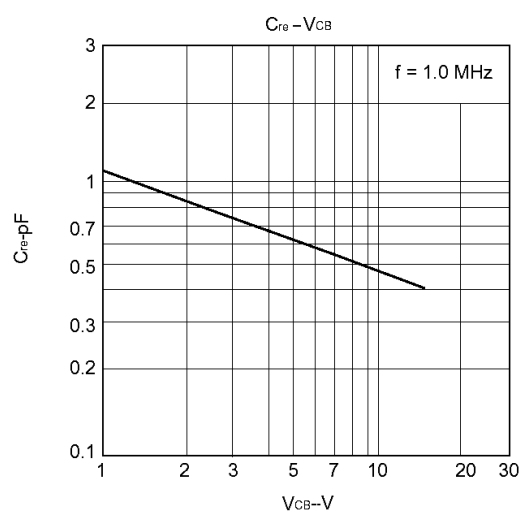
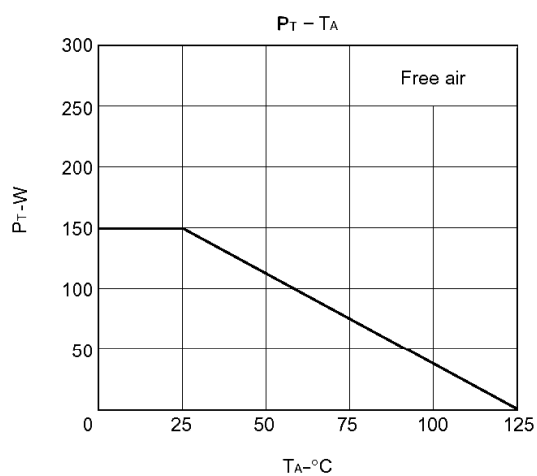
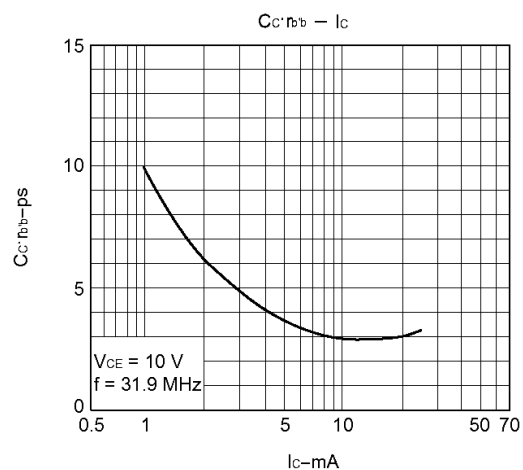
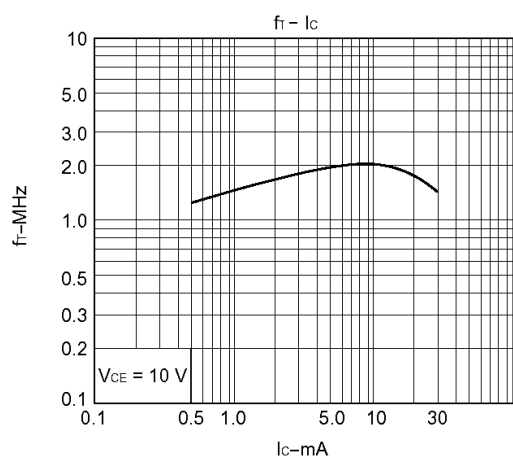
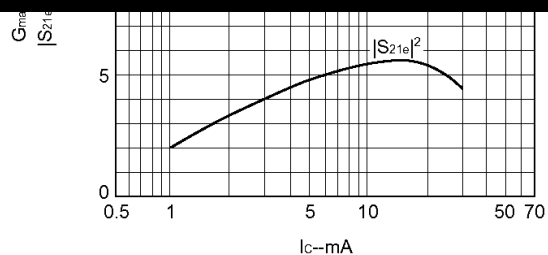
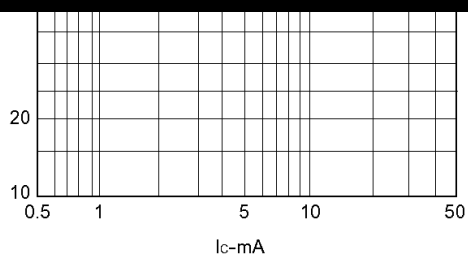
/ h_{FE} Classifications & Marking

	~	~	~

		~	

						μ

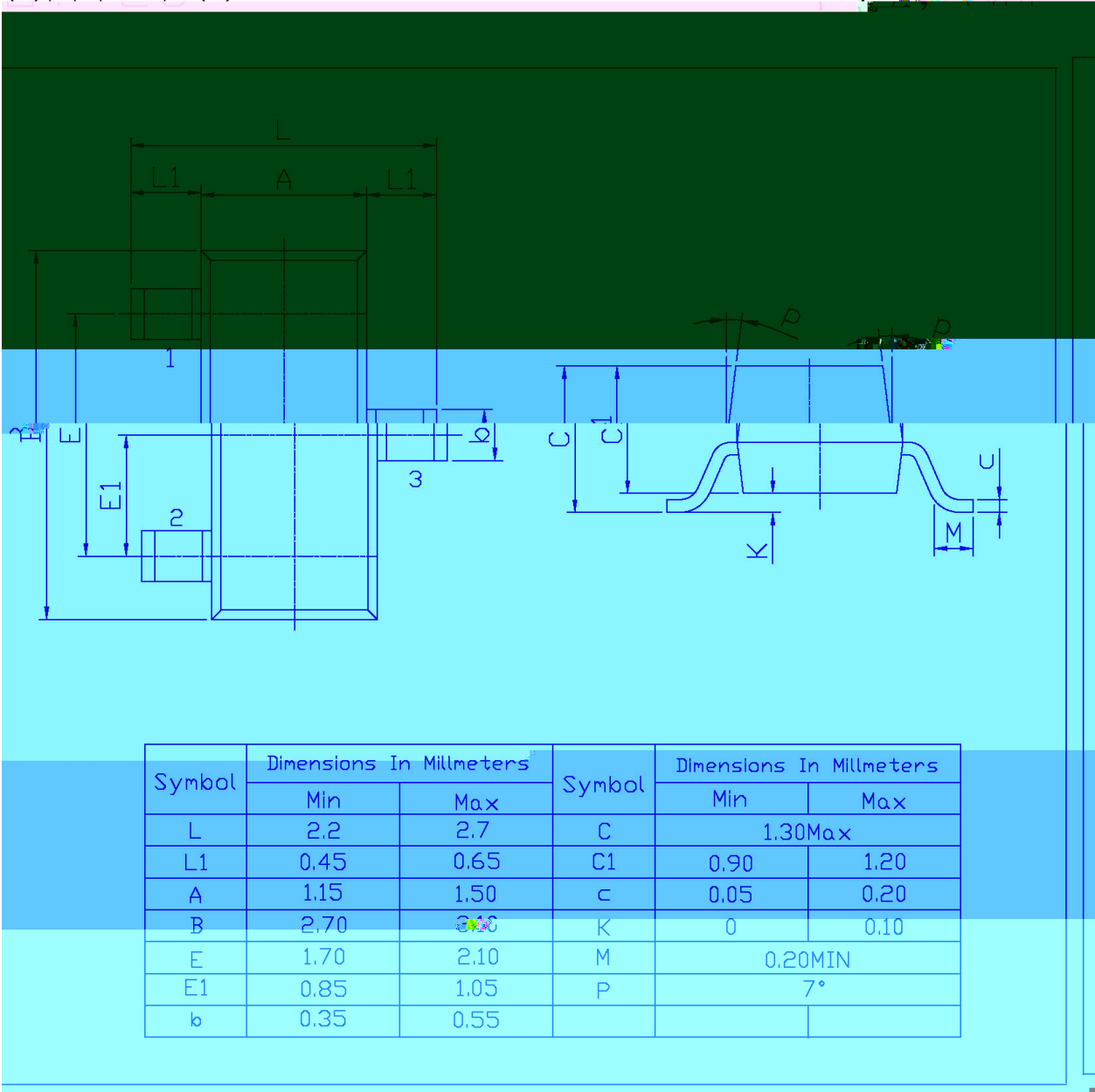
I Electrical Characteristic Curve

 $h_{FE} - I_C$ $|S_{21e}|^2 / G_{max} - I_C$ 

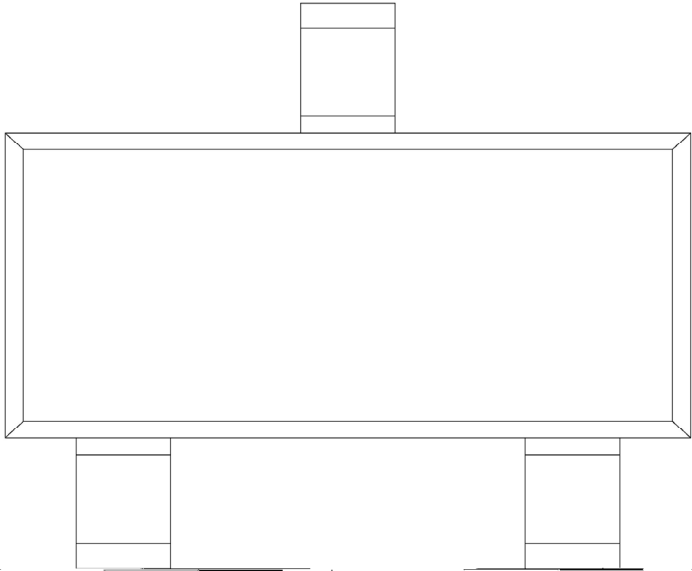
/ Package Dimensions

SOT-23

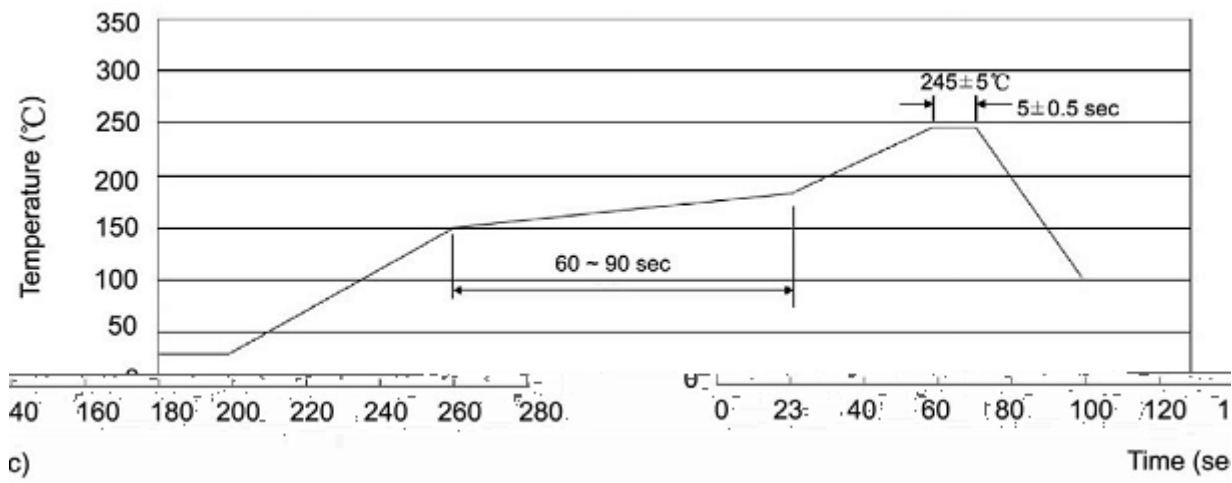
单位: mm



/ Marking Instructions



() /



/ Resistance to Soldering Heat Test Conditions

/ Packaging SPEC.

封装形式	包装数量					包装尺寸		
	只 卷盘	卷盘 盒	只 盒	盒 箱	只 箱		盒	箱
						"		

/ Notices